

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT2914300

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JEN-SHOU HSU	06/17/2014
PO-HSUN WU	06/17/2014
RECEIVING PARTY DATA	
Name:	ELITE SEMICONDUCTOR MEMORY TECHNOLOGY INC.
Street Address:	NO. 23, INDUSTRY E. ROAD IV
Internal Address:	HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	30077
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14315127
CORRESPONDENCE DATA	
Fax Number:	(202)289-5870
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-408-5153
Email:	dolive@mmmlaw.com
Correspondent Name:	MORRIS MANNING & MARTIN LLP
Address Line 1:	IP DEPARTMENT
Address Line 2:	1401 EYE STREET, N.W., SUITE 600
Address Line 4:	WASHINGTON, D.C. 20005
ATTORNEY DOCKET NUMBER:	ESMT.0007 (28086-97428)
NAME OF SUBMITTER:	JUAN CARLOS A. MARQUEZ
SIGNATURE:	/juan.carlos.a.marquez/
DATE SIGNED:	06/25/2014
Total Attachments: 2	
source=ESMT-7_Assignment#page1.tif	
source=ESMT-7_Assignment#page2.tif	

ASSIGNMENT


WHEREAS, **Jen-Shou HSU** and **Po-Hsun WU**, whose post office address(es) appear below hereinafter referred to as ASSIGNOR, have invented certain new and useful improvements in **TEST SYSTEM AND DEVICE** (hereinafter referred to as THE INVENTION) for which an application for United States Letters Patent was filed on _____, Application Number _____, or is being filed herewith;

WHEREAS, **ELITE SEMICONDUCTOR MEMORY TECHNOLOGY INC.**, whose post office address is No. 23, Industry E. Road IV, Hsinchu Science Park, Hsinchu 30077, Taiwan, R.O.C. (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the same in the United States and throughout the world;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, we, ASSIGNOR, by these presents do sell, assign and transfer until said ASSIGNEE, the entire right, title and interest in and to said invention and application throughout the United States of America, including any and all United States Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application; and the entire right, title and interest in and to said invention throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said invention.

ALSO, ASSIGNOR here by agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for said invention, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said invention, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the invention that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behalf; and for the use and behalf of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Name: Jen-Shou HSU	Signature 
Address: 17F-2, No. 6, Ln. 175, Wuling Rd., North Dist., Hsinchu 300, Taiwan, R.O.C.	Date 6/17/2014

Name: Po-Hsun WU	Signature Po-Hsun WU
Address: No. 61, Ln. 2, Zhongzheng W. Rd., Mituo Dist., Kaohsiung City 827, Taiwan, R.O.C.	Date 6/17/2014